

# Multiplexed readout of uniform arrays of TES x-ray microcalorimeters suitable for Constellation-X

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## ABSTRACT

Following our development of a superconducting transition-edge-sensor (TES) microcalorimeter design that enables reproducible, high performance (routinely better than 3 eV FWHM energy resolution at 6 keV) and is compatible with high-fill-factor arrays, we have directed our efforts towards demonstrating arrays of identical pixels using the multiplexed read-out concept needed for instrumenting the Constellation-X X-ray Microcalorimeter Spectrometer (XMS) focal plane array. We have used a state-of-the-art, time-division SQUID multiplexer system to demonstrate  $2 \times 8$  multiplexing (16 pixels read out with two signal channels) with an acceptably modest level of degradation in the energy resolution. The average resolution for the 16 multiplexed pixels was 2.9 eV, and the distribution of resolution values had a relative standard deviation of 5%. The performance of the array while multiplexed is well understood. The technical path to realizing multiplexing for the XMS instrument on the scale of 32 pixels per signal channel includes increasing the system bandwidth by a factor of four and reducing the non-multiplexed SQUID noise by a factor of two.

In this paper we discuss the characteristics of a uniform  $8 \times 8$  array and its performance when read out non-multiplexed and with various degrees of multiplexing. We present data acquired through the readout chain from the multiplexer electronics, through the real-time demultiplexer software, to storage for later signal processing. We also report on a demonstration of real-time data processing. Finally, because the multiplexer provides unprecedented simultaneous access to the pixels of the array, we were able to measure the array-scale uniformity of TES calorimeter parameters such as the individual thermal conductances and superconducting transition temperatures of the pixels. Detector uniformity is essential for optimal operation of a multiplexed array, and we found that the distributions of thermal conductances, transition temperatures, and transition slopes were sufficiently tight to avoid significant compromises in the operation of any pixel.

**Keywords:** microcalorimeters, transition-edge sensors, time-division SQUID multiplexing, Constellation-X

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## 1. INTRODUCTION

We have been developing arrays of superconducting transition-edge sensor (TES) x-ray calorimeters compatible with the reference design of the X-ray Microcalorimeter Spectrometer (XMS) instrument on Constellation-X, a future x-ray observatory under formulation by NASA. The XMS field of view is to be  $5.5 \text{ arcmin} \times 5.5 \text{ arcmin}$ , sampled at 5 arcsec. The highest spectral resolution, 2.5 eV full width at half maximum (FWHM), is required of the central quarter of the array, or  $2.7 \text{ arcmin} \times 2.7 \text{ arcmin}$ , while the rest of the array need only achieve a resolution of 10 eV. Our plan to meet these requirements is to fill the focal plane with a combination of a high-performance core array and a field-of-view extension. The baseline concept for the core array is a  $32 \times 32$  array of 5-arcsec, independent calorimeters. The core array is the subject of this paper; progress on our concept for filling the rest of the focal plane with position-sensitive TES calorimeters is discussed elsewhere in these proceedings.<sup>1</sup>

An  $8 \times 8$  array of independent TES calorimeters with a pitch of 0.25 mm has been the basic format for our development of a robust pixel design. Each pixel consists of a Mo/Au TES thermometer with an electroplated Au or Au/Bi x-ray absorber on a thermally isolating silicon-nitride membrane. Direct contact between the absorber and the TES film is limited to a small, insensitive area of the TES so that the low-resistance absorber neither shunts current away from the TES nor interferes with its sensitivity as a thermometer. We have previously presented this design concept,<sup>2</sup> as well as performance and detailed characterization of pixels with variations in the absorber composition and attachment geometry.<sup>3,4,5,6</sup> Here we present the next step in the maturation of this design – the production of arrays of nominally identical pixels and the subsequent verification of that uniformity.

Superconducting quantum interference devices (SQUIDs) are well matched to reading the current signals from these low-resistance (typically a few  $\text{m}\Omega$  under optimal bias) sensors. Multiplexed readout is motivated by the need to reduce the number of wires running to the low temperature stages of the instrument for effective management of heat loads and design complexity. In our present time-division multiplexing (TDM) concept,<sup>7</sup> the outputs from the dedicated input SQUIDs of individual TES pixels are coupled to a single amplifier, and multiplexing is achieved by sequential switching of these input SQUIDs. Fig. 3 (left) illustrates the NIST TDM concept. Additional reduction in wire count is achieved by using common bias lines for multiple TES bias circuits; each bias circuit consists of a shunt resistor, the TES, the SQUID input coil, and additional inductance for filtering the detector response. Columns of individual bias circuits are biased in series with a common dc current. In parallel with the array development, the design of the multiplexed SQUID read-out electronics progressed to the level appropriate for a  $2 \times 8$  demonstration of the readout of high-resolution TES signals with  $\sim 0.3 \text{ ms}$  fall times.<sup>8,9</sup>

A milestone on the Constellation-X/XMS technology road map had been a demonstration of multiplexed

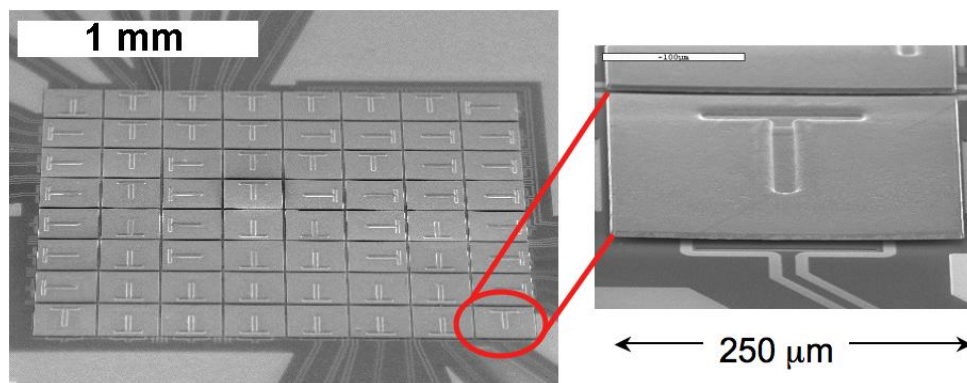


Figure 1. Electron micrograph of a uniform TES array with Au/Bi absorbers. The close-up view on the right shows an individual pixel. The absorber is cantilevered over the underlying substrate everywhere except in the T-shaped contact area. This array scheme is directly scalable to  $32 \times 32$  except for the density of the signal wires, which is the next development milestone to be pursued.

readout of 16 TES pixels with fall times shorter than 1 ms using two readout channels (i.e.  $2\times 8$  multiplexing) and achieving better than 4 eV resolution at 6 keV on all 16 pixels. Combining the GSFC uniform array with the NIST SQUID multiplexer, we have surpassed the goals of this demonstration by a wide margin, as we detail in Sec. 4.1.

## 2. UNIFORM TES ARRAY

While continuing to study the optimization of the design of individual pixels, we have chosen one design to use for a demonstration of array uniformity and to test multiplexed readout (see Fig. 1). The TES thermometers are 0.14 mm square Mo/Au bilayers deposited by electron-beam evaporation. Additional Au features, borders on the edges parallel to the current flow and three interdigitated stripes perpendicular to the current flow, are deposited atop the TES to control detector noise and the transition shape.<sup>3</sup> The transition temperature was  $\sim 0.1$  K. Mo/Nb leads make electrical contact to each TES. Each TES is situated on a 1  $\mu\text{m}$  thick silicon-nitride membrane suspended above a separate etched well in the silicon substrate wafer. The absorbers are 0.24 mm wide on a 0.25 mm pitch and consist of 3  $\mu\text{m}$  Bi electroplated atop 2.5  $\mu\text{m}$  of Au that had been electroplated up from a 0.2  $\mu\text{m}$  evaporated seed layer. The absorbers make contact to the plane of the sensors only in a T-shaped area; the stem of the T is placed at the middle noise-mitigating stripe of the TES, and the cross bar of the T contacts the membrane directly outside of the TES and provides mechanical stability for the absorber. In each  $8\times 8$  array, there are wires leading only to half of the pixels in order to leave room on the die for diagnostic devices and a heatsinking Au contact.

Two identical arrays were tested at GSFC, and one of these arrays was subsequently operated in the  $4\times 32$  time-division SQUID multiplexer platform at NIST, as will be discussed in Sec. 4. The testbed at GSFC also employs a NIST SQUID multiplexer, an older  $2\times 12$  system, in an adiabatic demagnetization refrigerator (ADR). Both systems can be used to study one pixel (per multiplexer column) at a time for characterization of resolution without impact from multiplexing. The multiplexer can also be used to measure the physical characteristics of many pixels simultaneously, such as through measurements of the complex impedance.

The GSFC tests included measurement of the physical parameters of several pixels for a heat-sink temperature,  $T_b$ , of 50 mK and an early investigation of the feasibility of multiplexing the array. The value of  $R_n$ , the resistance of a TES when not superconducting, was  $\sim 7$  m $\Omega$ . During non-multiplexed operation, a spectral resolution of 2.30 eV was measured on one pixel. This measurement was consistent, within statistical error, with the measured noise level of 2.18 eV. The optimal bias for this device, based on a scan of the signal-to-noise ratio vs. bias, was determined to be  $\sim 17\%$  of  $R_n$ , consistent with previous devices with this absorber-attachment design. From a determination of the power required to heat the TES into its transition as a function of  $T_b$ , the thermal conductance,  $G$ , was determined to be  $234$  pW/K  $\pm$  5 pW/K, and  $T$  at the operating resistance was determined to be 94.7 mK. A quick scan of  $T_c$  across the array, where  $T_c$  is defined at the top of the superconducting transition, found  $T_c$  to vary from 95.3 to 97.0 mK over 22 pixels, with all but one of those falling between 96 and 97 mK. The heat capacity was measured on two pixels by increasing  $T_b$  to a value within the transition, applying a small bias voltage so that the operating point was at the top of the transition, and measuring the time constant,  $\tau$ , of x-ray pulses acquired in this configuration. Because there is negligible electrothermal feedback in such a configuration, the heat capacity,  $C$ , is given by  $C = \tau G$ . For both pixels, we determined  $C = 0.86$  pJ/K.

In order to characterize the detector response, the GSFC testbed was also used to record the transfer functions (from the bias through the output) on multiple pixels simultaneously through use of the multiplexer. The complex impedance of each pixel, as a function of bias resistance and frequency, is obtained from such transfer functions. The complex impedance of a calorimeter is a manifestation of its electrothermal feedback, and thus is sensitive to the electrical and thermal time scales of the device. Fitting a model to the impedance curves can be useful for determining detector parameters such as  $\alpha$  ( $\equiv (T/R)\partial R/\partial T|_I$ , where  $R$ ,  $T$ , and  $I$  are resistance, temperature, and current) and  $\beta$  ( $\equiv (I/R)\partial R/\partial I|_T$ ), especially if  $C$ ,  $G$ , and the values of the circuit components are fixed by other measurements. Fig. 2 shows impedance traces taken on six devices biased in common. The traces from different pixels are similar, especially low in the transition where the detectors are operated. Because of the common bias, the similarity of the curves verifies the uniformity of the components of the bias circuits as well as the pixels themselves. We fitted these data for one of the pixels at the 15% bias point and determined  $\alpha = 76.37$  and  $\beta = 1.24$ . In order to predict the performance, we need to specify the Johnson noise level associated with

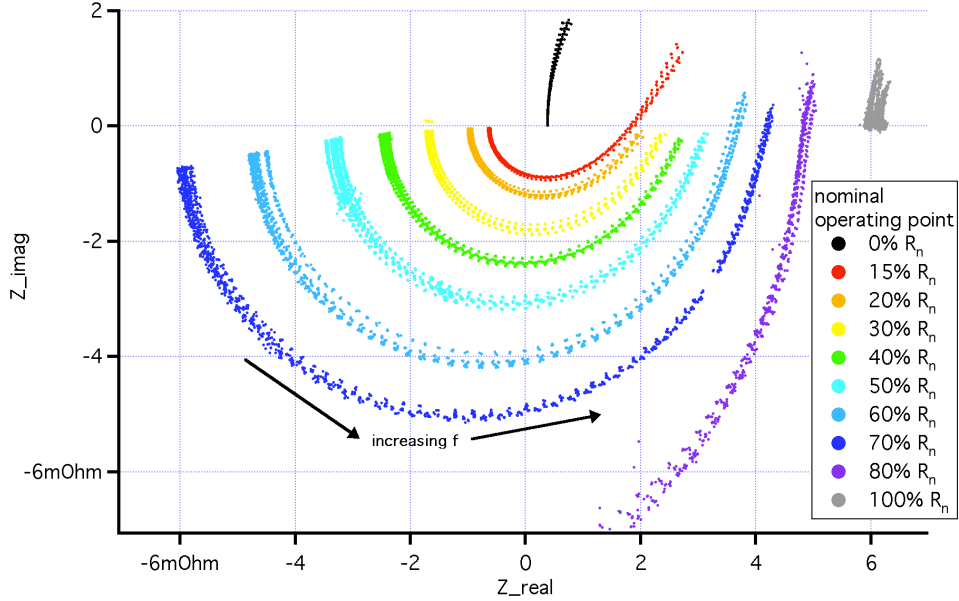


Figure 2. Complex impedance curves for six pixels biased in common and measured through the multiplexer. The bunched curves are for different devices at the same applied bias; the series runs from tight curves low in the transition to wide curves at the top. (The nominal bias points indicated, e.g. 15 %  $R_n$ , are exact for one of the pixels and are valid for the other pixels to the extent that the pixels and bias circuits are uniform.) The traces from different pixels are similar, especially low in the transition where the detectors are operated. Because the complex impedance of a calorimeter is sensitive to the electrical and thermal time scales of the device, detector parameters can be determined from fitting models to the impedance curves.

the device at its operating point. We have established, for other devices operated with similar bias currents,<sup>3</sup> that the power of this voltage noise is  $4k_B TR(1 + 2\beta)$  [ $V^2/Hz$ ], the expression for Johnson noise in a non-linear device,<sup>10</sup> and the noise of the present devices is consistent with this expression at the operating point. With the inclusion of the measured amplifier noise, the detector model predicts a resolution of  $\sim 2.2$  eV. This is close to the resolution measured on a different pixel. If the readout noise were negligible, a device with these parameters would have a resolution of 1.9 eV when biased at 15%  $R_n$  and anchored to a 50 mK heat sink.

### 3. MULTIPLEXER SET-UP

Detailed studies of the multiplexed readout were conducted at NIST. The GSFC detector array was installed in a 4-column  $\times$  32-channel SQUID time-division-multiplexer testbed. The detector and the front-end electronics, which are capable of reading out up to 128 microcalorimeters, are pictured in Fig. 3. A two-stage ADR cooled the detector plane, and allowed full array operation for more than 8 hours per cycle with a 70.5 mK heatsink temperature (choice of temperature discussed below). Custom-developed room-temperature electronics<sup>11</sup> controlled the multiplexed row switching and digital feedback application.

The open-loop bandwidth of the multiplexer system was measured to be about 1.7 MHz, and was limited by the coupling of the second-stage SQUID to the series-array SQUID (see Fig. 3). A 2.5 MHz anti-aliasing filter was placed before the error-signal-sampling analog-to-digital converter (ADC). The open-loop (non-multiplexed) SQUID noise, averaged over the channels connected to detectors, was measured to be  $0.61 \mu\Phi_0/\sqrt{Hz}$ . The input coupling from each detector to its input SQUID was  $M_{in1}^{-1} = 7.53 \mu A/\Phi_0$ . Each 680-ns row-switching cycle consisted of 600 ns of settling, followed by four 20-ns ADC samples that were averaged to yield the measurement for that cycle.

The total inductance,  $L$ , in each TES bias circuit must be tuned for optimal combined performance of the detector and multiplexer. This inductance serves two functions – to suppress the detector noise at frequencies

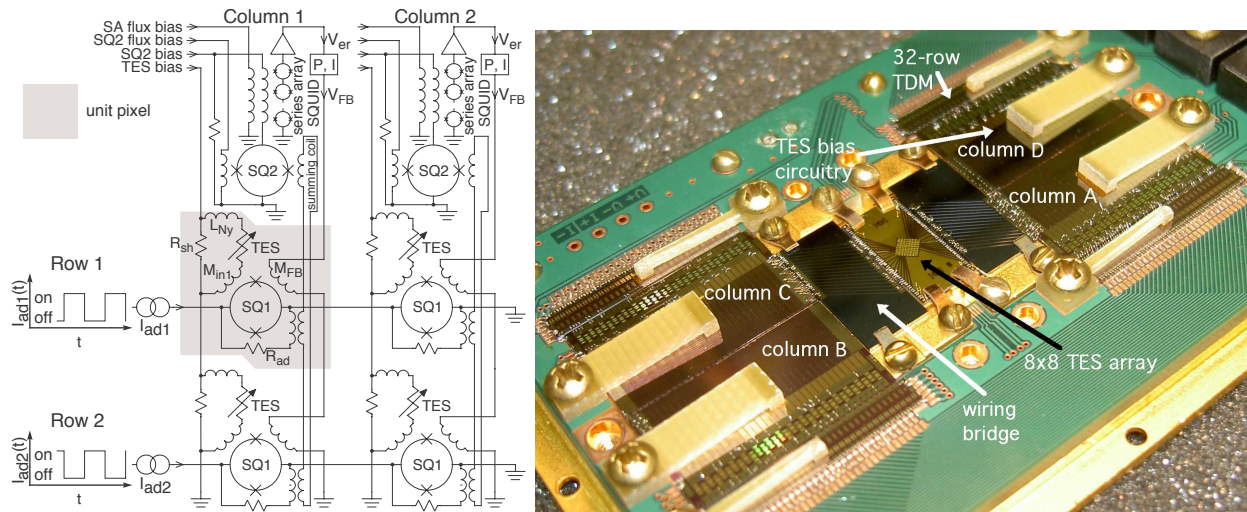


Figure 3. (left) Schematic of a 2-row  $\times$  2-column SQUID-time-division multiplexer, used to illustrate a general  $N$ -row  $\times$   $M$ -column array. The TES bias circuits of each column are connected in series and are supplied with a constant current. Each TES is inductively coupled ( $M_{in1}$ ) to its own first-stage SQUID amplifier (SQ1). Extra inductance,  $L_{Ny}$ , is included in each bias circuit to filter the detector response. An inductive summing coil carries the output signals from all SQ1's in a column to a common second-stage SQUID (SQ2). Rows of SQ1's are sequentially turned on (or addressed, using  $I_{ad}$ ), so the signal from one TES at a time per column is passed to that column's SQ2. When a SQ1 is off, it acts like a superconducting wire, transmitting no signal or noise from its TES. Finally, the output of each SQ2 is routed to a 100-SQUID, series-array amplifier and then to room-temperature electronics. In order to keep the nonlinear three-stage SQUID amplifier in a small, linear range, the multiplexer is run as a flux-locked feedback loop. The series array output, or error signal ( $V_{er}$ ), is digitally sampled, and then a flux-feedback signal ( $V_{FB}$ ) is applied inductively to the first-stage SQUIDs to regulate  $V_{er}$  to a constant value. With perfect feedback,  $V_{FB}$  would be directly proportional to the TES current; in a real system, the TES current is determined from a linear combination of  $V_{FB}$  and  $V_{er}$ . Electronics synchronize the row-address and flux-feedback signals and stream the data to a computer. A kilopixel array could be read out with a 32-row  $\times$  32-column TDM. (right) Photograph of the detector plane, showing the 64-pixel GSFC detector array in the 4-column  $\times$  32-row NIST TDM testbed. An amplifier column consists of a  $1 \times 32$  linear multiplexer chip, an interface chip with TES shunt resistors and Nyquist inductors, and its associated detectors. A wiring bridge chip was fabricated to connect the GSFC detector to the Nyquist interface chip. 16 rows in each of two columns (A and C) were connected to detectors, while B and D were not used. The detector array was heat-sunk to the copper cold stage via Au wire bonds.

above the Nyquist frequency of the multiplexer frame rate and to slow down the pulse rise time so that pulses do not exceed the system slew-rate limit. Stability considerations limit how high the inductance can be, since the inductance interacts with the electrothermal feedback of the TES to create a resonance as the electrical time constant approaches the thermal time constant. The optimal choice,  $L_{crit}$ , is the inductance value that leads to critical damping;<sup>12</sup> this results in the slowest rise times and fastest fall times for a particular set of detector characteristics. Fig. 4 shows modeled pulses, based on the detector characteristics measured at GSFC under optimal bias with  $T_b = 50$  mK. Two cases are shown:  $L \sim 0$  and  $L = L_{crit}$ . Critical damping would be achieved with  $L = 152$  nH, however the lowest inductance available on existing Nyquist interface chips was 263 nH, resulting in  $L = 273$  nH when combined with the input inductance of the first stage SQUID.

To create operating conditions so that  $L_{crit} = 273$  nH,  $T_b$  was raised to 70.5 mK to reduce the loop gain associated with the electrothermal feedback thereby slowing down the detector response. The detector operating temperature remained at the superconducting transition temperature, but less current was required to bias it at this operating point. Running with an elevated value of  $T_b$  has several negative effects on the ideal detector performance – it increases the detector sensitivity to fluctuations in  $T_b$ , it slightly increases the magnitude of the thermal fluctuation noise between the detector and the heat sink, and it reduces the signal and thermal noise terms with respect to the Johnson noise, reducing the signal bandwidth over which the signal-to-noise ratio is high. On the positive side, besides enabling slower rise times that make multiplexing easier, operation at

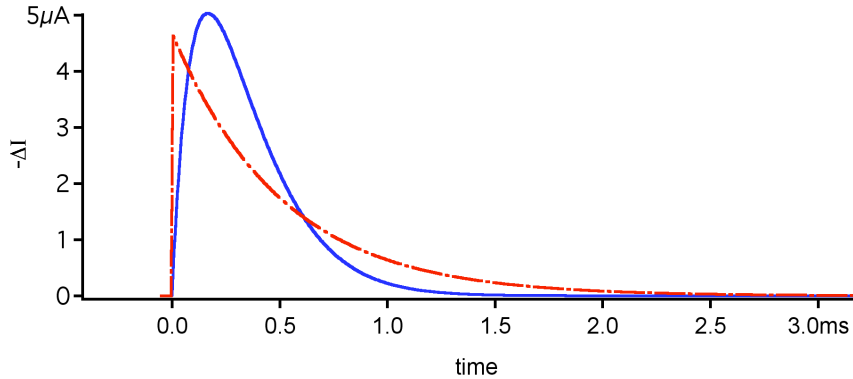


Figure 4. Simulated pulse response for absorption of a 1 keV x-ray photon, based on detector characteristics measured at GSFC for optimal bias at  $T_b = 50$  mK (see discussion in Sect. 2), assuming a  $0.3$  m $\Omega$  biasing shunt resistor. Real pulses are actually decrements in current; the value plotted is the steady-state current minus the signal. Two cases are shown:  $L \sim 0$  (dashed) and  $L = L_{\text{crit}}$  (critical damping, solid). Although the critically damped pulse peaks later than the pulse for  $L \sim 0$ , it returns to the quiescent level sooner. For this case,  $L_{\text{crit}} = 152$  nH and  $\tau_{\text{crit}} = 0.17$  ms.

reduced current can improve sensitivity by reducing noise in a non-ideal device. We discuss the modest overall impact of higher  $T_b$  on the intrinsic resolution of the detector in Sec. 4.2 as we analyze the incremental impact of multiplexing on this base value. Critically damped pulses take the functional form  $Ate^{-t/\tau_{\text{crit}}}$ , where  $t$  is time and  $A$  is a scale factor; for the conditions of the NIST demonstration,  $\tau_{\text{crit}}$  was  $0.28$  ms.

Data acquisition is controlled by discrete software modules: 1) a user interface that sets the SQUID and detector biases, the dwell time on each row, and the digital feedback parameters; 2) a server that demultiplexes the data stream into the individual pixel signals (both error and feedback) and makes these parallel streams available on the network; and 3) clients that can access the data. One client is based on the calorimeter digital processor of the XRS instrument on Suzaku<sup>13,14</sup> and provides real-time pulse processing. Preliminary results obtained while employing this system in this new application are discussed in Sec. 5. Another client functions as a digital oscilloscope and saves triggered data records for later optimal filtering and analysis. This client was used to acquire the data presented in Sec. 4. This client also communicates with the server and controls characteristics of the data stream, such as whether the error signal should be combined with the raw feedback signal and the scale factors to use for this mixing if it is enabled. While the relationship between the feedback voltage and the TES current depends only on the relative coupling of the feedback and input lines and the value of the feedback resistance, the relationship between the feedback and error signals also depends on the slope of the combined  $V$ - $\Phi$  curve of the SQUID amplifier chain. This slope is easily measured by increasing the feedback gain in order to produce oscillations in the feedback signal, and then adjusting the error-signal scale factor so that, when the error is added to the feedback signal, the root-mean-square value of the sum (in the absence of pulses) is minimized. In addition to streaming data on the network, the server can also save raw data streams to disk that can be played back by another server. Such playback is useful for development of the clients and to use as control data for comparison of different analysis techniques.

## 4. OPERATION OF GSFC TES ARRAY WITH NIST MULTIPLEXER

### 4.1 Demonstration of $2 \times 8$ readout

An  $^{55}\text{Fe}$  source mounted inside the cryostat provided an x-ray flux of  $1.8$  counts/s/pixel. The average operating resistance,  $\langle R_{\text{op}} \rangle$ , of the 16 pixels was  $15\%$   $R_n$ , while the range of bias resistances of individual pixels ranged from  $13.5\%$  to  $16.4\%$ . The multiplexer switched between rows every 34 cycles of the  $50$  MHz master clock, or  $0.68$   $\mu\text{s}$ , thus the frame period was  $5.44$   $\mu\text{s}$ , which represents the sample interval for the signal from an individual pixel. Triggered records of 8192 samples ( $44.6$  ms) each were recorded over about 4.5 hours for an average of 30,000 events per pixel. Data cuts to reject pile-up eliminated  $8\%$  of the pulses, which is consistent with the expected record-rejection rate of a non-paralyzable detector with dead time =  $44.6$  ms and input count rate

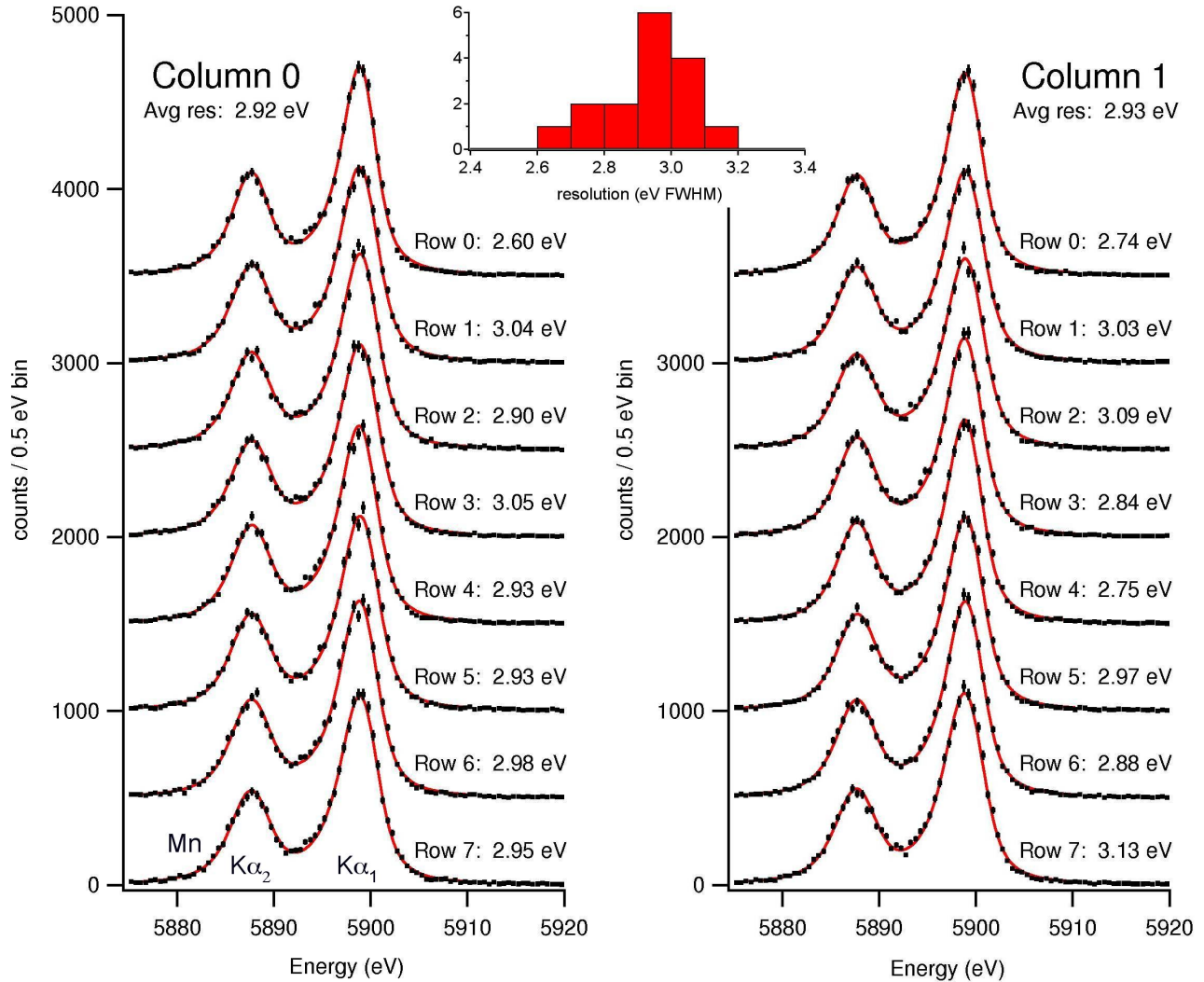


Figure 5. Results of the  $2 \times 8$  multiplexing demonstration; the spectra for the individual pixels in a column are vertically offset by 500 counts/bin. The data were acquired and processed under the following conditions:  $T_b = 70.5$  mK,  $\langle R_{op} \rangle = 15\%$   $R_n$ , row dwell time =  $0.68 \mu s$ , frame time =  $5.44 \mu s$ , 8192 frames per triggered record, 1.8 counts/s/pixel input count rate (limited by cryogenic  $^{55}Fe$  source), 30,000 counts/pixel, no data cuts other than pile-up rejection performed, gain drift and sampling phase corrections performed, and fits based on Hölzer et al.,<sup>15</sup> with correction and extension provided by Hölzer via private communication. These results are a significant milestone for the development of TES technology suitable for the XMS instrument on Constellation-X.

= 1.8 counts/s.<sup>16</sup> No other data cuts were performed. An optimal digital filter<sup>17</sup> was used to determine the best estimate of energy; the value of the filter in the 0 Hz frequency bin was set to zero to remove contribution from the quiescent signal level. Drift in gain over time was removed by use of a third-order-polynomial scale correction. The dependence of filtered pulse height on sampling phase (the arrival time of the photon within a sample interval) was determined and also corrected. The energy scale was determined from a linear fit to the Mn  $K\alpha_1$  and Mn  $K\alpha_2$  peak positions. The energy resolution of each channel was then determined by fitting the natural line shape of the Mn  $K\alpha$  doublet, convolved with the detector resolution, to the accumulated spectra. The line shape was based on the profile determined by Hölzer et al.,<sup>15</sup> with correction and extension provided by Hölzer via private communication. Fig. 5 shows the individual fits to the 16 pixels and a summary histogram of the 16 results. The  $1\sigma$  statistical errors on the determination of the individual resolution values were  $\sim 0.07$

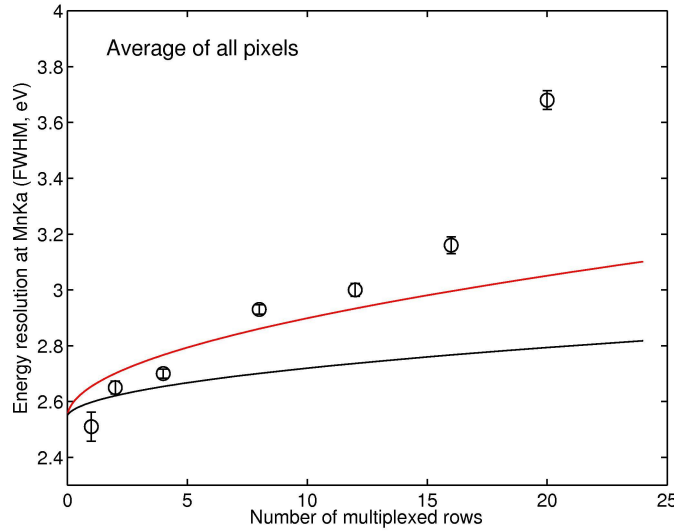


Figure 6. Plot of the average measured resolution (circles with error bars) compared with the expected energy resolution (upper curve) based on the aliased SQUID noise term, as a function of the number of multiplexed rows. The lower curve is the prediction for the case of a factor of two reduction in SQUID noise. With a factor of four faster switching, the good match between theory and data now seen out to 8 rows will be extended out to the 32 rows needed for the Constellation-X XMS. Both improvements should be achievable with incremental (and planned) changes to the existing architecture.

eV. The average resolution was 2.9 eV FWHM, and the distribution of resolution values had a relative standard deviation of 5%. Each pixel surpassed the 4 eV requirement for this demonstration milestone by a wide margin.

## 4.2 Performance versus number of multiplexed rows

The effect of the readout on the detector energy resolution was assessed by multiplexing various numbers of detector pixels per amplifier channel. An expected source of signal degradation is the aliasing of SQUID noise by the multiplexer. In order to switch rapidly among the rows and allow the error signal to settle before sampling, the multiplexer must have a very high open-loop bandwidth (here,  $f_{OL} = 1.7$  MHz). As the number of rows,  $N_{rows}$ , increases, each row is sampled less often. The Nyquist sampling condition,  $f_{samp} \geq f_{signal}/2$ , is not met for the SQUID noise. This leads to a SQUID noise term of the form  $n_{SQUID-muxed} = n_{SQUID-notmuxed} \sqrt{\pi f_{OL} N_{rows} t_{row}}$  that adds in quadrature to the TES noise.<sup>9</sup> Fig. 6 is a plot of the average measured resolution compared with the expected energy resolution based on the aliased SQUID noise term, as a function of the number of multiplexed rows. This expected resolution is based on the average over four modeled pixels from the multiplex demonstration that spanned the ranges of measured pulseheights and SQUID noise. The data point for a single row (not-multiplexed) is the average of 3 pixels. The 2-row and 4-row data points average the same 16 pixels as the 2-column  $\times$  8-row case discussed in Sect. 4, through multiple acquisitions. The 12-row point is an average of the 16 of the 24 pixels that were part of the  $2 \times 8$  data set. One of the columns wouldn't operate stably when multiplexing more than 12 rows, so the 16- and 20-row points are based on the average results from the 8 pixels in one column in common with the 8-row case. In the 20-row measurement, 4 SQUIDs that weren't connected to detectors were included in the multiplexer cycle.

The data in Fig. 6 follow the expected resolution well for 1, 2, 4, 8, and 12 rows. For 16 and 20 rows, the energy resolution degrades more rapidly than can be accounted for in this model. As the frame interval increases with increasing row count, the dependence of filtered pulse height on sampling phase also increases. We determine this arrival phase by solving for the coefficients of a parabola defined by the peak three points of the optimally filtered pulse. From these coefficients, we determine an interpolated peak value and the time of that peak between the discrete samples of the measurement. With larger sample intervals, the peak three points cover a larger span of the filtered pulse. Eventually, the assumption that the encompassed peak can be



adequately described by a parabola breaks down, resulting in a correlation between pulse height and sampling phase. In this demonstration, correcting the data for this correlation was an effective remedy for measurements using up through 12 rows. For 16 rows and above, this method was less effective.

Fig. 6 also includes a lower theoretical curve that shows the effect of lowering the SQUID noise to  $0.30 \mu\Phi_0/\sqrt{\text{Hz}}$  (non-multiplexed), in contrast with the  $0.61 \mu\Phi_0/\sqrt{\text{Hz}}$  average measured in this demonstration. With a factor of four faster switching, the good match between theory and data now seen out to 8 rows will be extended to 32 rows. Both improvements should be achievable with incremental (and planned) changes to the existing architecture.

The base resolution of 2.5 eV measured in the NIST experiments, which is then degraded by multiplexing, is itself degraded by the higher temperature operation of the detector heat sink. With  $T_b = 50 \text{ mK}$ , the detector model discussed in Sect. 2 predicts a resolution of 1.9 eV if sources of noise external to the detector are not significant, and this degrades to 2.2 eV when the modeled heat sink temperature is raised to 70 mK. In the case in which non-multiplexed SQUID noise degrades the 50 mK case to 2.2 eV, the predicted resolution for  $T_b = 70 \text{ mK}$  becomes 2.5 eV. Thus, for reasonable levels on non-multiplexed amplifier noise, 50 mK operation (as planned for XMS) results in resolution about 0.3 eV better than achievable at 70 mK, and will provide more margin for the aliased SQUID noise inherent in multiplexing.

### 4.3 Study of array uniformity

The results of Sec. 4 show that the properties of the pixels of the array were sufficiently uniform to achieve high-resolution performance under common detector bias. Fig. 7 is a map of the two active quadrants of the array (one pixel, marked with an “x”, was open, probably due to a bad wire bond) showing the measured distributions of  $T_c$  and  $G$ . The distribution of  $T_c$  shows no discernable pattern. Due to disagreement between the thermometry calibrations in the NIST and GSFC testbeds, these  $T_c$  values are higher than the values measured at GSFC. The measurements of  $G$  were performed on one quadrant at a time. The apparent pattern showing lower  $G$  toward the middle of each quadrant is probably an artifact resulting from the bias power increasing the effective heat-sink temperature. The variations in  $G$  and also in the shapes of the superconducting transitions resulted in a range in bias points from 13.5% to 16.4% of  $R_n$  at a common bias chosen to yield an average bias resistance of 15%. Plots of signal-to-noise vs. bias point of detectors of this design are flat in the 13% - 17% range, thus this degree of variation was acceptable. The biases of the two columns were independently optimized.

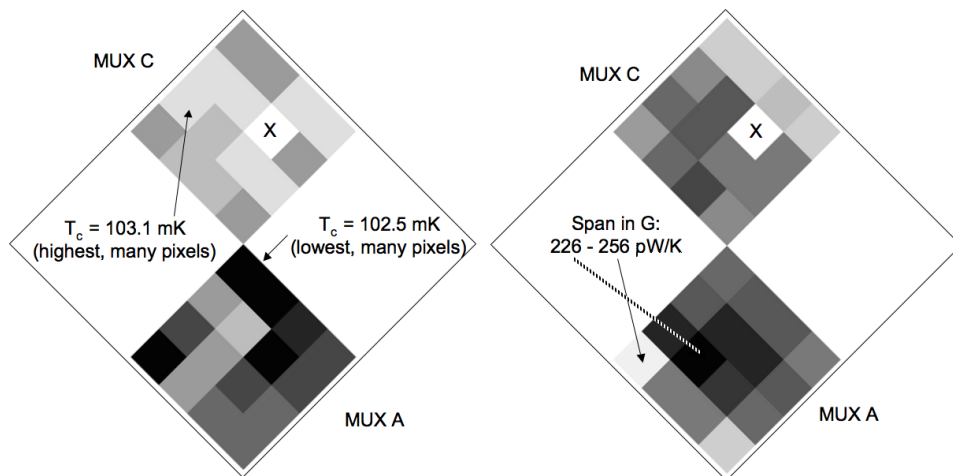


Figure 7. Plot of the distributions of  $T_c$  (left) and  $G$  (right) in the active quadrants of the test array. With the 16 pixels in each quadrant under common bias, the variations in  $G$  and in the shapes of the superconducting transitions resulted in a range in bias points from 13.5% to 16.4% of  $R_n$ . Plots of signal-to-noise vs. bias point of these detectors are flat in the 13% - 17% range, thus this degree of variation was acceptable. One pixel, marked with an “x”, was not measurable, presumably due to a failed wire bond.

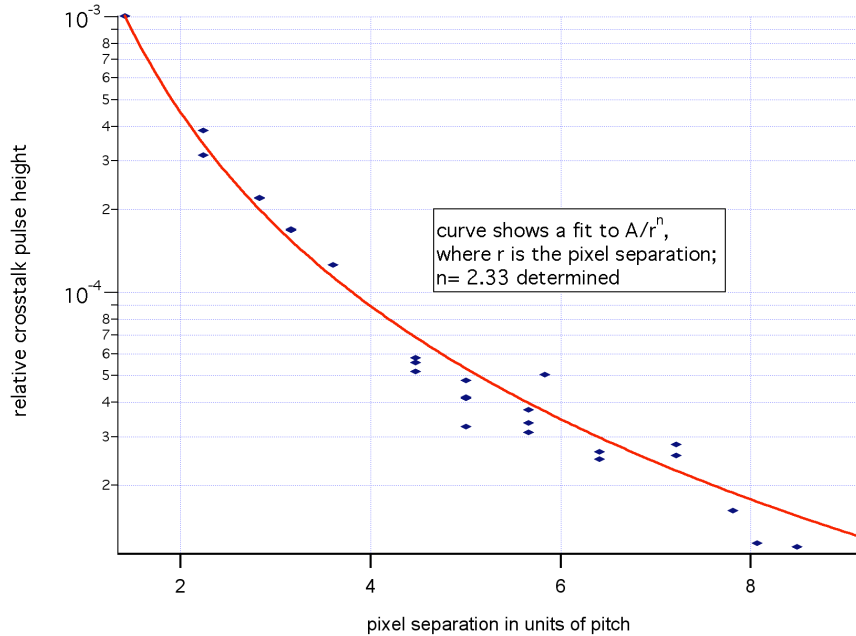


Figure 8. Height of thermal crosstalk as a function of pixel separation, as measured through the multiplexer. The dependence of crosstalk amplitude on pixel separation,  $r$ , falls slightly more steeply than  $1/r^2$ , suggesting that diffusion through the silicon between pixels in the array is the primary heatsinking bottleneck.

#### 4.4 Crosstalk

Simultaneous readout of a large number of pixels in an array allows in-depth crosstalk studies. We have already performed limited but detailed analysis of thermal crosstalk on previous test arrays.<sup>18</sup> Crosstalk pulses are too small to be confused for x-ray photons, therefore crosstalk contributes to noise, not background, and can result in energy resolution that depends on the incident x-ray flux. The level of crosstalk in our present arrays needs to be reduced by a factor of  $\sim 10$ , based on preliminary analysis, in order to meet the XMS resolution requirement at count rates approaching 1000 counts/s/pixel. We are performing investigations into improving the thermal design of the array in order to reduce the crosstalk magnitude. In the multiplexed data, thermal crosstalk can be unambiguously seen between pixels in different readout columns. Recent results are summarized in Fig. 8. The rough dependence of crosstalk on position suggests that diffusion within the silicon in the interior of the array is limiting the thermal anchoring of the pixels, as also suggested by the pixel  $G$  measurements described above. Within a column, multiplexer-induced crosstalk is also observed, known sources of which include heating of non-superconducting wires in the printed circuit boards of the test bed and coupling between the input and feedback coils of the first-stage SQUID.<sup>7</sup> Detailed analysis of multiplexer-induced crosstalk will occur in a future publication.

### 5. DATA ANALYSIS ISSUES

Analysis of large data sets of critically damped, multiplexed pulses has revealed two issues that need further study before an instrument can be designed. The first effect is the dependence of filtered pulse height on sampling phase discussed in Sect. 4.2. A study of the range of optimally filtered pulse shapes expected, given realistic noise and detector characteristics that meet the requirements for a particular application such as the XMS instrument, may reveal a more appropriate functional form for interpolation than a parabola. The multiplexer contributes to this effect beyond the basic problem of sparse sampling. Because the signal is recreated from a linear combination of the error signal and the feedback signal, it is important that the deviation from the lock point remain within the linear part of the combined SQUID  $V$ - $\Phi$  curve. Different sampling phase on the initial fast rise of a pulse can

result in different degrees of excursion into the non-linear regime; this effect would also depend on pulse energy. Faster row switching times and new SQUIDs with extended linear regimes will help address this issue.

The second issue is the choice of record length for pulse analysis. The record length sets the size of the frequency bins used to calculate the optimal filter. Because the dc level is included in the zero-frequency bin, but represents a source of noise (due to the fact that it is a component of the signal that does not scale with energy, as well as to any slow changes in that level), the optimal filter value for this bin is often set to zero. Even when not explicitly zeroed, the dc level suppresses this bin when the optimal filter is calculated. The shorter the record, the greater the proportion of the passband of the filter that is lost when this bin is set to zero. Electrothermal feedback and critical damping both result in hastening the return of a calorimeter to its quiescent level, but neither of these effects changes the frequency spectrum of the signal-to-noise ratio significantly. Therefore, the signal-to-noise ratio remains highest at low frequencies, and nulling out a large fraction of that sensitivity degrades the resolution. For this demonstration, a generous record length of 45 ms was chosen, but our models and test results indicate that the record length could have been reduced by about a factor of 4 before having significant impact on the resolution. In order to shorten the necessary record length by another factor of 10 or so to enable the high count rates that should otherwise be allowed given the fast detector response times, we plan to investigate alternative analysis methods. We are considering methods that permit retention of the zero-frequency bin in the optimal filter, such as tracking an average of the dc level on time scales much longer than a record.

Automatic pulse processing is essential in orbit and convenient on the ground. We have conducted a preliminary test of applying real-time optimal filtering derived from the Suzaku/XRS calorimeter digital processor by playing back recorded  $2 \times 8$  multiplexed data at approximately the real-time rate. The client calculates an optimal filter for each pixel based on a set of noise and pulse thresholds and then applies that filter to the incoming data. The final product is an event list that includes information for each event such as filtered pulse height, time, sampling phase (parabolic approximation), and various flags. After correcting for gain drift and phase dependence and determining an energy scale for one test pixel, a resolution of 3.1 eV was measured. Manual analysis of saved triggered records from the same data stream resulted in a resolution of 2.7 eV. The cause of the degradation is under investigation, but we are confident that real-time data processing for performance at the level of 2 eV resolution will soon be possible.

## 6. CONCLUSIONS

We have reached an important milestone in the development of TES array technologies suitable for the XMS instrument on Constellation-X. We have produced an array of pixels sufficiently uniform that they can be biased in common without significant compromise in the operation of any pixel. We have demonstrated an average resolution of 2.9 eV with a relative standard deviation of 5% on 16 pixels read out with a 2-column  $\times$  8-row SQUID multiplexer. We have characterized multiplexing up to 20 rows. The path to improvement is to move the series array SQUIDs to the 50 mK stage (from 4 K) to eliminate stray inductance, enabling increase of the open-loop bandwidth to the 6-7 MHz range. Room-temperature electronics are under development to match this performance. Reduction of SQUID noise by factor of two (to  $0.3 \mu\Phi_0/\sqrt{\text{Hz}}$ ) is achievable by, among other improvements, better heatsinking of the SQUID chips to the thermal bath. These straightforward improvements will enable results like those demonstrated here to be realized for 32-row multiplexing, enabling a kilopixel array to be read out with 32 amplifier channels. The base pixel resolution, to which the multiplexer effects are added, will be improved when the detectors are heat sunk to 50 mK (instead of 70 mK) and are matched with a suitable inductance, which will, in turn, improve the resolution while multiplexed.

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